

SUPPLEMENTAL/BID BULLETIN NO. 1
For LBP-ICTBAC- ITB-GS-20241202-01 (2)

PROJECT : Additional Memory Modules for the Existing Hyperconverged Infrastructure (HCI) Appliance with Three (3) Years Warranty and Support Services

DATE : 19 June 2025

This Supplemental/Bid Bulletin is issued to modify, amend and/or clarify certain items in the Bid Documents. This shall form an integral part of the Bid Documents.

1. Change the date of bid submission and opening of bids.

A. Bid Submission

From	To
27 June 2025 at 10:00 AM	01 July 2025 at 10:00AM

B. Bid Opening

From	To
27 June 2025 at 10:15 AM	01 July 2025 at 10:15 AM

2. The bidder/s are encouraged to use the Bid Securing Declaration as Bid Security.



FVP GRACE OFELIA LOVELY V. DAYO
Vice-Chairperson, ICT-BAC